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(54) **METHOD OF MANUFACTURING DISPLAY DEVICE**

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(71) Applicant: **Japan Display Inc.**, Tokyo (JP)

(72) Inventors: **Masaru TAKAYAMA**, Tokyo (JP);  
**Takanobu TAKENAKA**, Tokyo (JP);  
**Hirofumi MIZUKOSHI**, Tokyo (JP);  
**Yuki HAMADA**, Tokyo (JP)

(73) Assignee: **Japan Display Inc.**, Tokyo (JP)

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(57) **ABSTRACT**

According to one embodiment, a method of manufacturing a display device, includes forming a lower electrode on a base including a first main surface and a side surface, the lower electrode being on the first main surface of the base, forming a rib including a pixel aperture, forming a partition on the rib, forming a first deposition film which includes a first organic layer which covers the lower electrode via the pixel aperture and a first upper electrode which covers the first organic layer and forming a first sealing layer which covers the first deposition film. The first sealing layer includes a first upper end portion which covers the first deposition film and a first side end portion which covers the side surface.

